| V <sub>RRM</sub>    | = | 2500 V  |
|---------------------|---|---------|
| I <sub>FAVM</sub>   | = | 950 A   |
| I <sub>FSM</sub>    | = | 21 kA   |
| V <sub>F0</sub>     | = | 1.2 V   |
| r <sub>F</sub>      | = | 0.38 mΩ |
| V <sub>DClink</sub> | = | 1500 V  |

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# Fast Recovery Diode 5SDF 11F2501

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- Patented free-floating silicon technology
- Low on-state and switching losses
- Optimized for use as freewheeling diode in GTO converters
- Standard press-pack housing, hermetically cold-welded
- Cosmic radiation withstand rating

### Blocking

| V <sub>RRM</sub>    | Repetitive peak reverse voltage               | 2500 V  | Half sine wave, $t_P$ = 10 ms, f = 50 Hz |  |  |
|---------------------|---|---------|--|--|--|
| I <sub>RRM</sub>    | Repetitive peak reverse current               | ≤ 50 mA | $V_{R} = V_{RRM,} T_{j} = 125^{\circ}C$  |  |  |
| $V_{\text{DClink}}$ | Permanent DC voltage for 100 FIT failure rate | 1500 V  | 100% Duty                                | Ambient cosmic radiation at sea level in open air. |  |
| V <sub>DClink</sub> | Permanent DC voltage for 100 FIT failure rate | V       | 5% Duty                                  |  |  |

### Mechanical data (see Fig. 12)

| E              | Mounting force m                                    | nin. |   | 20 kN                                       |
|----------------|---|------|---|---|
| F <sub>m</sub> |   | ax.  |   | 24 kN                                       |
| а              | Acceleration:<br>Device unclamped<br>Device clamped |      |   | 50 m/s <sup>2</sup><br>200 m/s <sup>2</sup> |
| m              | Weight  |      |   | 0.46 kg                                     |
| Ds             | Surface creepage distance                           |      | ≥ | 30 mm                                       |
| Da             | Air strike distance                                 |      | ≥ | 20 mm                                       |



## On-state (see Fig. 2, 3)

| I <sub>FAVM</sub> | Max. average on-state current | 950 A                                | Half sine wave, $T_c = 85^{\circ}C$    |
|-------------------|-------------------------------|--------------------------------------|--|
| I <sub>FRMS</sub> | Max. RMS on-state current     | 1500 A                               |  |
| I <sub>FSM</sub>  | Max. peak non-repetitive      | 21 kA                                | tp = 10 ms Before surge:               |
|                   | surge current                 | 65 kA                                | $tp = 1 ms T_c = T_j = 125^{\circ}C$   |
| ∫l²dt             | Max. surge current integral   | 2.2.10 <sup>6</sup> A <sup>2</sup> s | tp = 10 ms After surge:                |
|                   |                               | 2.1.10 <sup>6</sup> A <sup>2</sup> s | tp = 1 ms $V_R \approx 0 V$            |
| $V_{F}$           | Forward voltage drop          | $\leq$ 1.6 V                         | I <sub>F</sub> = 1000 A                |
| $V_{F0}$          | Threshold voltage             | 1.2 V                                | Approximation for $T_j = 125^{\circ}C$ |
| r <sub>F</sub>    | Slope resistance              | 0.38 mΩ                              | I <sub>F</sub> = 4004000 A             |

# Turn-on (see Fig. 4, 5)

| $V_{\rm fr}$ | Peak forward recovery voltage | $\leq$ | 16 V | di/dt = 500 A/µs, T <sub>j</sub> = 125°C |
|--------------|-------------------------------|--------|------|--|
|--------------|-------------------------------|--------|------|--|

## Turn-off (see Fig. 6 to 11)

| Irr             | Reverse recovery current | $\leq$ | 550 A   | di/dt = 300 A/ $\mu$ s, I <sub>F</sub> = 700 | А, |
|-----------------|--------------------------|--------|---------|--|----|
| Q <sub>rr</sub> | Reverse recovery charge  | ≤      | 1200 µC | $T_j = 125^{\circ}C, V_{RM} = 2$             |    |
| Err             | Turn-off energy          | $\leq$ | 0.45 J  | $C_s = 2\mu F$ (GTO snubber circuit)         |    |

# Thermal (see Fig. 1)

| Tj               | Operating junction temperature range | -40125°C  |                     |                  |
|------------------|--------------------------------------|-----------|---------------------|------------------|
| T <sub>stg</sub> | Storage temperature range            | -40125°C  |                     |                  |
| $R_{thJC}$       | Thermal resistance junction to case  | ≤ 40 K/kW | Anode side cooled   |                  |
|                  |                                      | ≤ 40 K/kW | Cathode side cooled | F <sub>m</sub> = |
|                  |                                      | ≤ 20 K/kW | Double side cooled  | 20 24 kN         |
| $R_{thCH}$       | Thermal resistance case to heatsink  | ≤ 10 K/kW | Single side cooled  |                  |
|                  |                                      | ≤ 5 K/kW  | Double side cooled  |                  |

Analytical function for transient thermal impedance.

$$Z_{\text{thJC}}(t) = \sum_{i=1}^{n} R_{i}(1 - e^{-t/\tau_{i}})$$

| i  | 1     | 2    | 3    | 4    |  |  |
|--|-------|------|------|------|--|--|
| R <sub>i</sub> (K/kW)                                  | 11.83 | 4.26 | 1.63 | 2.28 |  |  |
| $\begin{array}{ c c c c c c c c c c c c c c c c c c c$ |       |      |      |      |  |  |
| F <sub>m</sub> = 20 24 kN Double side cooled           |       |      |      |      |  |  |

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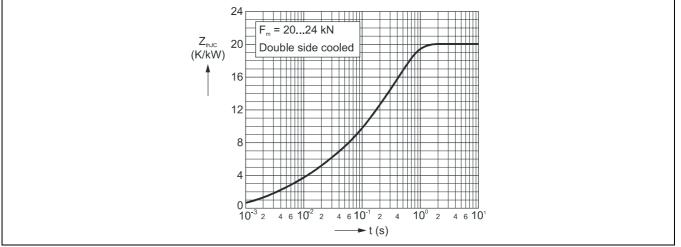


Fig. 1 Transient thermal impedance (junction-to-case) vs. time in analytical and graphical form (max. values).

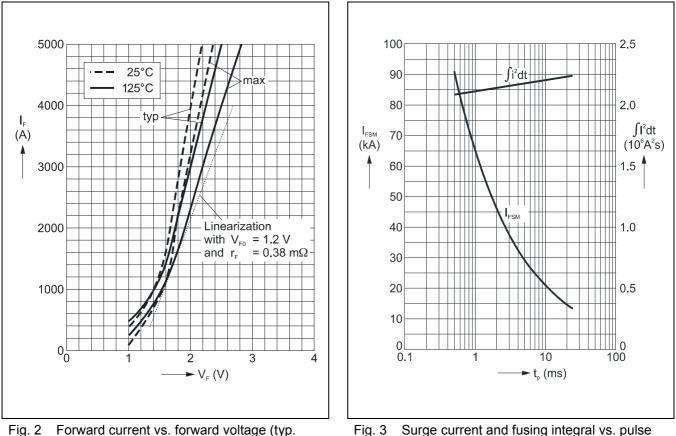
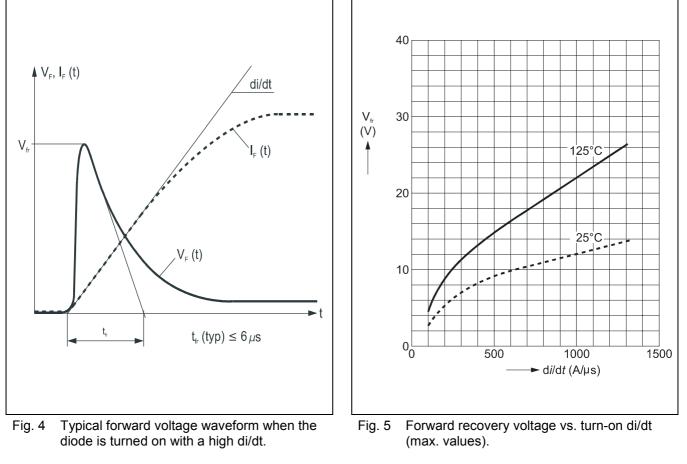


Fig. 2 Forward current vs. forward voltage (typ. and max. values) and linear approximation of max. curve at 125°C.

Fig. 3 Surge current and fusing integral vs. pulse width (max. values) for non-repetitive, half-sinusoidal surge current pulses.



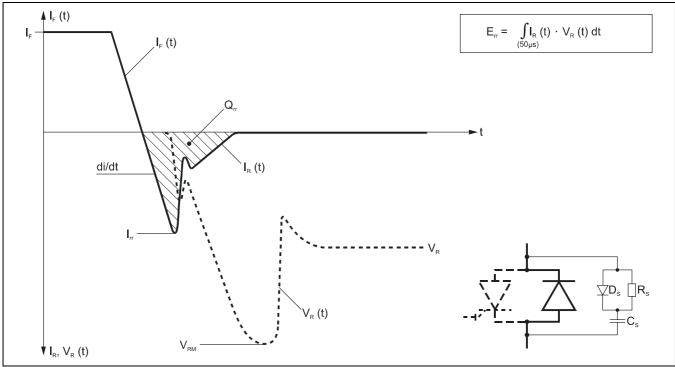
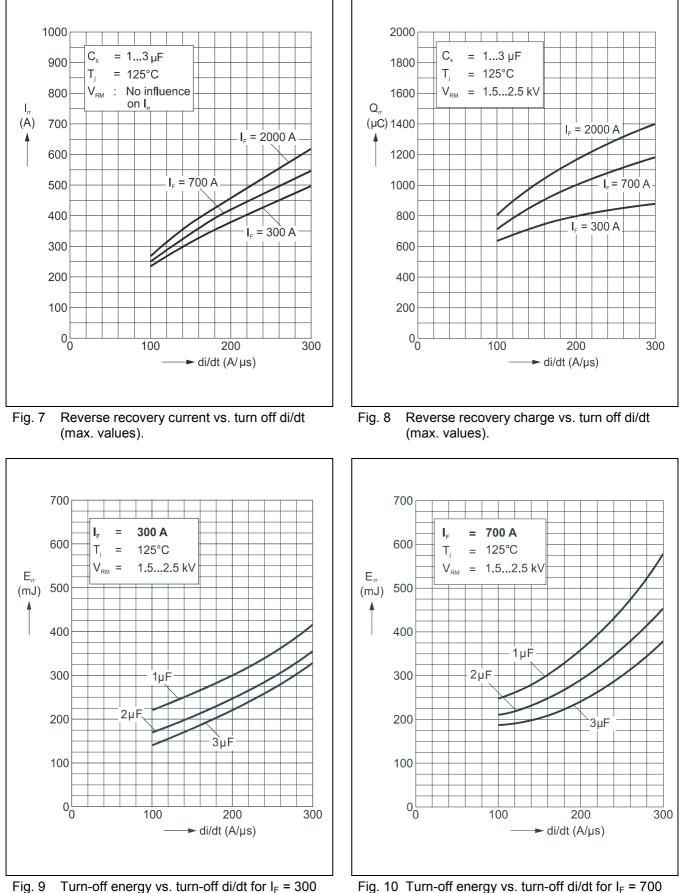


Fig. 6 Typical current and voltage waveforms at turn-off when the diode is connected to an RCD snubber, as often used in GTO circuits.



Turn-off energy vs. turn-off di/dt for  $I_F$  = 300 A (max. values).

Fig. 10 Turn-off energy vs. turn-off di/dt for  $I_F = 700$ A (max. values).

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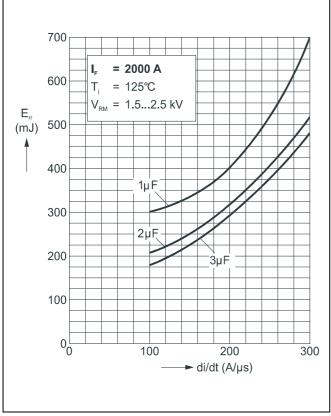


Fig. 11 Turn-off energy vs. turn-off di/dt for  $I_F$  = 2000 A (max. values).

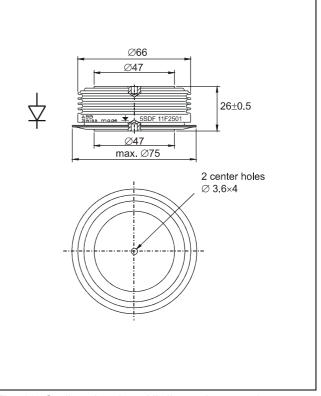


Fig. 12 Outline drawing. All dimensions are in millimeters and represent nominal values unless stated otherwise.

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